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August 2016

FFSP08120A

Silicon Carbide Schottky Diode 1200 V, 8 A

Features

- Max Junction Temperature 175 °C
- · Avalanche Rated 80 mJ
- · High Surge Current Capacity
- · Positive Temperature Coefficient
- · Ease of Paralleling
- · No Reverse Recovery / No Forward Recovery

Applications

- · General Purpose
- · SMPS, Solar Inverter, UPS
- · Power Switching Circuits

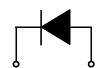
Description

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material - Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size/cost. Its high reliability ensures robust operation during surge or over-voltage conditions



1. Cathode

2. Anode



1,3 Cathode 2. Anode

Absolute Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Parameter	FFSP08120A	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	1200	V
E _{AS}	Single Pulse Avalanche Energy (Note 1)	80	mJ
I _F	Continuous Rectified Forward Current @ Tc < 148 °C	8	Α
I _{F, Max} Non-F	Non-Repetitive Peak Forward Surge Cur- T _C = 25 °C, 10 μs	530	Α
	rent $T_{\rm C}$ = 150 °C, 10 µs	480	Α
I _{F,SM}	Non-Repetitive Forward Surge Current Half-Sine Pulse, t _p = 8.3 ms	68	Α
I _{F,RM}	Repetitive Forward Surge Current Half-Sine Pulse, t _p = 8.3 ms	32	Α
Ptot	T _C = 25 °C	166	W
	Power Dissipation $T_C = 150 ^{\circ}\text{C}$	27	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C

Thermal Characteristic

Symbol	Parameter	FFSP08120A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	0.9	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FFSP08120A FFSP08120A TO-220-2L		Tube	N/A	N/A	50 units	

Electrical Characteristics $T_C = 25$ °C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
		I _F = 8 A, T _C = 25 °C	-	1.45	1.75	
V_{F}	Forward Voltage	I _F = 8 A, T _C = 125 °C	-	1.7	2	V
		I _F = 8 A, T _C = 175 °C	-	2	2.4	
		$V_R = 1200 \text{ V}, T_C = 25 ^{\circ}\text{C}$	-	-	200	
I_{R}	Reverse Current	$V_R = 1200 \text{ V}, T_C = 125 ^{\circ}\text{C}$	-	-	300	μΑ
		$V_R = 1200 \text{ V}, T_C = 175 ^{\circ}\text{C}$	-	-	400	1
Q_C	Total Capacitive Charge	V = 800 V	-	55	-	nC
		V _R = 1 V, f = 100 kHz	-	538	-	
С	Total Capacitance	$V_R = 400 \text{ V}, f = 100 \text{ kHz}$	-	50	-	pF
		$V_R = 800 \text{ V}, f = 100 \text{ kHz}$	\ -	40	-	

Typical Characteristics $T_J = 25$ °C unless otherwise noted.

Figure 1. Forward Characteristics

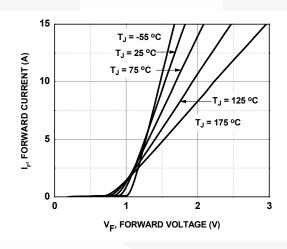


Figure 3. Reverse Characteristics

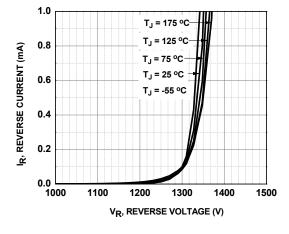


Figure 2. Reverse Characteristics

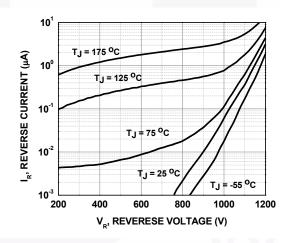
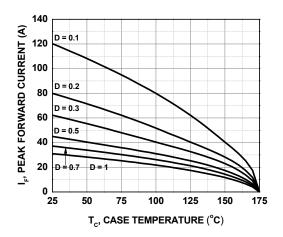


Figure 4. Current Derating



Notes: 1: EAS of 80 mJ is based on starting T_J = 25 °C, L = 0.5 mH, I_{AS} = 18 A, V = 150 V.

Typical Characteristics T_J = 25 °C unless otherwise noted.

Figure 5. Power Derating

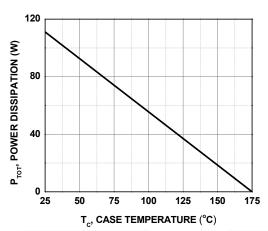


Figure 7. Capacitance vs. Reverse Voltage

Figure 6. Capacitive Charge vs. Reverse Voltage

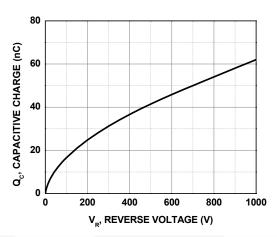
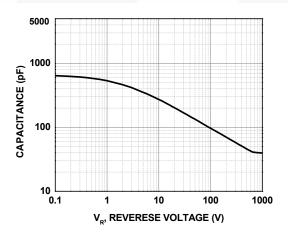


Figure 8. Capacitance Stored Energy



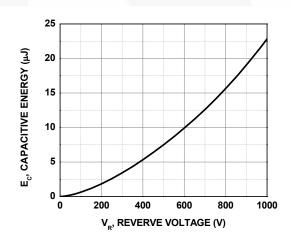
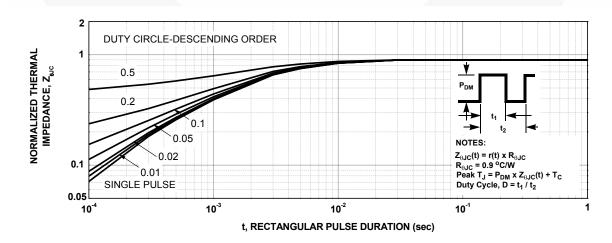
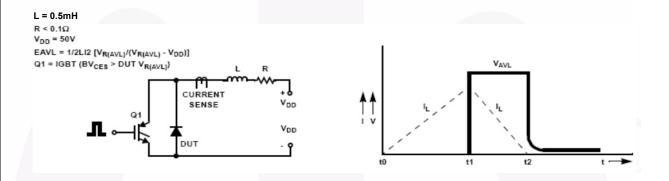


Figure 9. Junction-to-Case Transient Thermal Response Curve

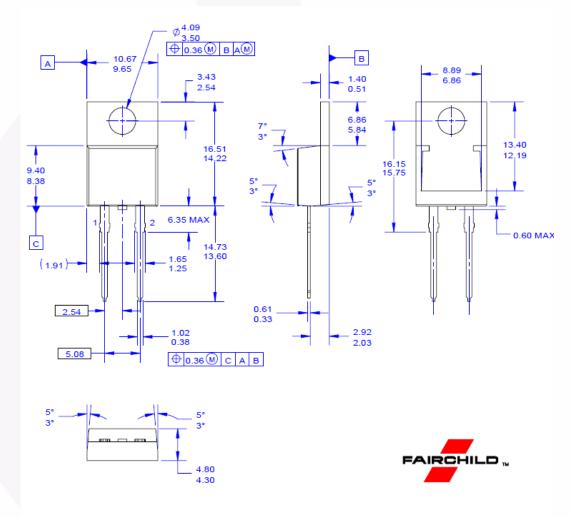


Test Circuit and Waveforms

Figure 10. Unclamped Inductive Switching Test Circuit & Waveform



Mechanical Dimensions



NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220, ISSUE K,
- VARIATION AC, DATED APRIL 2002. ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- DIMENSIONS ARE EXCLUSIVE OF BURRS
- MOLD FLASH AND TIE BAR PROTRUSIONS E. DRAWING FILE NAME: TO220A02REV5

Figure 11. TO-220 2L - TO-220, MOLDED, 2LD

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